502915033 07/31/2014

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:NEW ASSIGNMENTNATURE OF CONVEYANCE:ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Shian-Jyh Lin	09/12/2012
Jeng-Ping Lin	09/12/2012
Chin-Piao Chang	09/12/2012
Jen-Jui Huang	09/12/2012

RECEIVING PARTY DATA

Name:	NANYA TECHNOLOGY CORP.	
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State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14447634

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NAME OF SUBMITTER: KATE YEH

SIGNATURE: /KATE YEH/

DATE SIGNED: 07/31/2014

Total Attachments: 2 source=2019402#page1.tif source=2019402#page2.tif

PATENT 502915033 REEL: 033427 FRAME: 0688

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

Name:	Shian-Jyh Lin	Nationality:	TW		
Name:	Jeng-Ping Lin	Nationality:	TW		
Name:	Chin-Piao Chang	Nationality:	TW		
Name:	Jen-Jui Huang	Nationality:	TW		
Hereby sells, as	ssigns and transfers to				
ASSIGNEE(S)):				
Name:	NANYA TECHNOLOGY CORP.				
Address:	Hwa-Ya Technology Park 669, Fuhsing 3 Rd., Kueishan, Tao-Yuan Hsien, Taiwan, R.O.C.				
and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:					
"SEMICONDUCTOR MEMORY ARRAY STRUCTURE"					
Which is found in:					
	U.S. patent application executed on eve	en date			
(b) U.S. patent application executed on					
	U.S. application serial no.				
	patent no issu				
	International application no.				
. ,					

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F#NPO-P0002E-US1 DSC0-101U006726

ASSIGNOR(S) (Inventors):

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

SEP 1 2 2012 IN WITNESS WHEREOF, We have hereunto set hand and seal this Signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Shian-Jyh Lin

Jeng-Ping Lin

Chin-Piao Chang

Jen-Jui Huang

Signature of INVENTOR

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RECORDED: 07/31/2014